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#### DESCRIPTION

# PRODUCTION STABILIZING DEVICE AND METHOD FOR MULTICOMPONENT FILM AND COATED TOOL WITH MULTICOMPONENT FILM

TECHNICAL FIELD [0001]

The present invention relates to production stabilizing device and method which can more easily produce a nitride, a carbide, a boride, an oxide or a silicide containing two or more metal components such as TiAlN than prior art, and relates to a coated tool with a film formed by the method.

#### BACKGROUND ART

10 [0002]

A PVD (Physical Vapor Deposition) method has been known as a method of coating a product surface to give it abrasion resistance, oxidation resistance, corrosion resistance and other some functions.

An ion plating method, which is used as one of the PVD method and combines one part of a vacuum deposition method with a sputtering process, is a surface treatment method for forming a coating of a metal compound such as a metal carbide, a metal nitride and a metal oxide or a compound thereof. This method is now significant as the method of coating particularly the surface of a sliding member and a

cutting tool. [0003]

Conventionally, a nitride containing two or more metal components such as a TiAlN film has been exclusively produced by an arc process or a sputtering process.

However, these methods need an expensive alloy target serving as a vaporizing material and need to prepare the target of a composition according to an objective film composition. Further, the methods hardly use the whole of a raw material, by reason of an electromagnetic field and a holding method of the target. In addition, the arc process inevitably involves deposition of unreacted metal droplets and can not form a film with satisfactory quality. The sputtering process can form an extremely flat film, but has generally a small film-forming rate.

[0004]

On the contrary, a melting-evaporation type

ion plating method (hereafter referred to as a melting
method), has an advantage of evaporating most of a
charged raw material and a high material use
efficiency. This is particularly advantageous when
using a metal of high material unit cost or a hardly
formable metal as the raw material. However, the
conventional melting method has difficulty in uniformly
evaporating two or more sorts of metal materials with
remarkably different melting points.

[0005]

For instance, when two or more sorts of metal elements with largely different melting points such as Ti and Al are melted in the same crucible with a

5 conventional method, Al with a low melting point precedently melts and vaporizes, and subsequently Ti does. As a result, the obtained film has a composition affected by the difference of the melting points, specifically contains a high ratio of the low-melting

10 metal on a base metal side, and contains gradually a high ratio of the high-melting metal toward a surface layer.

Thus, the film containing two or more sorts of metal elements formed with the conventional method

15 has a distributed composition wholly depending on their melting points, and accordingly has had difficulty in controlling the composition distribution in a film thickness direction. It was almost impossible to control the film on the base metal side so as to

20 contain a higher ratio of the high-melting metal, and the film on the surface side so as to contain a higher ratio of the low-melting metal.

[0006]

In particular, when a melting material made

25 of an alloy is used as a starting material, a

sufficient unmelted portion is required to form a thick

film, the material has to have a large area. However,

a melted portion overlies the unmelted portion, and a

complicated control unit is required for moving the melted portion.

Such a situation is illustrated in Fig. 3.

Fig. 3 shows a state that a TiAlN film is formed using

5 a conventional melting material made of an alloy. The alloy 104 of the melting material is shaped to have a wide area and is placed in a water cooled 110 type crucible 103. Alloy vapor is ionized by converged plasma 107. The melted portion 104a of the alloy

10 largely overlaps with the unmelted portion 104b.

[0007]

In order to solve such a problem, a method of installing a plurality of evaporation sources in an ion plating apparatus has been adopted, for instance, as seen in JP-U-06-33956 (Fig. 1).

However, in order to provide the plurality of evaporation sources, the ion plating apparatus needs an additional power supply. Further, In addition, a filmforming rate by the melting method depends on a distance or positional relation of the evaporation source from or with an article to be vapor-deposited, but it is difficult for the apparatus having the plurality of evaporation sources to uniformize the positional relationship between the plurality of evaporation sources and the article to be vapor-deposited. For this reason, it is almost impossible to obtain a film having a consistent composition.

DISCLOSURE OF THE INVENTION

PROBLEM TO BE SOLVED BY THE INVENTION [0008]

Accordingly, it is desired to form a

5 multicomponent film containing metal components such as
TiAlN having greatly different melting points in
adequate quality, for instance, in which each component
of different metals is distributed at a desired rate
over the whole film thickness. It is also preferable

10 to form the film at high material use efficiency by
using a raw material alloy which has metal components
not required to be strictly matched with an objective
film composition but almost close to the objective film
composition, and of which the whole part can be

effectively used.

The invention has an object of providing production stabilizing device and method for forming such a multicomponent film and a tool coated with the film formed by using the method.

20 MEANS FOR SOLVING THE PROBLEM [0009]

Multicomponent film production stabilizing device and method according to the invention melt and evaporate a vaporizing material containing at least two sorts of metals, alloys or intermetallics compound in a single crucible or hearth and form a multicomponent film with use of plasma converged by an electric field or a magnetic field. At this time, a part of the

material is first melted and evaporated, and then an unmelted portion of the material is sequentially melted and evaporated.

[0010]

- It is preferable to conduct the sequential meting and evaporating of the unmelted material portion by supplying first electric power necessary for evaporating and then supplying electric power stepwise increased from the first electric power at
- 10 predetermined intervals repeatedly up the supply of necessary maximum electric power or by converging the plasma into a first plasma region necessary for evaporating the material and then sequentially moving and expanding the plasma from the first plasma region

  15 in a successive manner up to the maximum plasma region.

  [0011]

The above scheme allows a melted portion to be expanded during coating treatment for supplementing the metal of a low melting point.

As a result, it is possible to form a film in adequate quality, in which respective metal components with greatly different melting points of a metal such as TiAlN form a desired composition distribution over the whole film thickness by controlling the composition of a starting raw material and the melting rate of an unmelted portion. The vaporizing raw material does not need to be strictly matched with an objective film composition and may be an alloy having a metal

composition approximately close to the objective film composition.

[0012]

The raw material is preferably a sintered 5 compact or a green compact.

With the use of the sintered compact or the green compact, a melted portion can be separated from an unmelted portion. The raw material can be therefore effectively used almost in entirety with the unmelted portion sequentially melted and evaporated, and the 10 material use efficiency is high.

[0013]

A coated tool according to the invention has a cutting tool base material such as a high-speed tool steel, a die steel, a cemented carbide or a cermet, and the film of a nitride, a carbide, a boride, an oxide or a silicide containing a plurality of metal elements is formed on the base material by the above method according to the invention.

20 Thus, the coated tool with the superior film having desired composition distribution can be obtained.

MODE FOR CARRYING OUT THE INVENTION [0014]

25 The invention will be now described in detail with reference to an embodiment. At the outset, the development to the invention will be described.

The present inventors attempted to form a

TiAlN film under a condition of obtaining a general TiN

coating with the use of 50 g of a TiAl alloy as a

melting raw material. In this attempt, the TiAl alloy

was totally melted in a few minutes after having

started melting. The film thus obtained had a

composition in which Al was abundant on a base material

side and Ti was gradually abundant toward a surface

side. This is because Al has a lower melting point

than Ti and precedently vaporizes from the melted

material. The coating film thus obtained had a low

hardness and poorer adhesiveness as compared with a TiN

film.

Even when the TiAl alloy was increased in weight to make a part of the material melt, Al with a low melting point precedently vaporized and this gave the similar result.

Then, the inventors considered supplying Al 20 which was exhausted by evaporation, and conducted experiments of additionally charging Al into a melted material. However, it was difficult to balance melting and evaporation with the Al supply, and a satisfactory result was not obtained.

### 25 [0016]

[0015]

According to the conventional technique, it is general to control electric power used for melting a raw material to approximately constant electric power

determined to be optimum at first, except when starting melting.

The inventors inferred that if the electric power was increased in a stepped manner at

5 predetermined intervals during the melting, an unmelted portion would newly start melting and supplement a low-melting metal contained in the unmelted portion to the film. They repeated many experiments and could prove correctness of the inference.

## 10 [0017]

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Furthermore, according to the conventional technique, also in melting an unmelted portion by controlling an electric field or a magnetic field for converging plasma, it is general to control a plasma region used for melting a raw material to an approximately constant plasma region determined to be optimum at the beginning, except when starting melting.

The inventors inferred that a similar effect would be obtained by controlling the plasma so that the plasma region was continuously moved and expanded from the first region up to the maximum plasma region by sequentially moving and expanding the plasma. They repeated many experiments and could prove correctness of the inference.

# 25 [0018]

The present invention is based on such knowledge of the inventors as the above.

A production stabilizing device according to

the embodiment of the invention uses a sintered compact or a green compact containing at least two sorts of metals or intermetallics compound as a vaporizing raw material, melts and evaporates the raw material to form 5 a multicomponent film. The production stabilizing device has, as shown in Fig. 1, a vacuum chamber 1 for accommodating a member to be coated or a workpiece 2, and a single crucible or hearth 3 mounted in the chamber for receiving the green compact 4 of the raw 10 The device is further equipped with a power material. supply unit 6 including a HCD gun (Hollow Cathode Gun) 5, which supplies an electric power to the crucible to cause arc discharge, evaporates and ionizes the raw material by the generated heat and plasma 7, and a plasma control unit 9 including an electromagnetic coil 8 for controlling a magnetic field for converging the plasma when evaporating the raw material. [0019]

The production stabilizing device of the

20 embodiment may have the same construction as the

conventional apparatus according to the melting and

evaporating type ion plating method, except the power

supply unit 6 and the plasma control unit 9, and

further description on the same components will be

25 omitted.

The electric power supply unit 6 has a construction for sequentially-increased electric power supply which gradually increases electric power to be

supplied and sequentially melts the unmelted portion of the raw material.

The electric power supply unit 6 of the embodiment, when carrying out the sequentiallyincreased electric power supply, first supplies electric power of 3,000 W necessary for evaporating the raw material. The unit then supplies electric power increased by 500 W from the electric power supplied immediately before at an predetermined interval of one minute. The electric power increased by 500 W is thus repeatedly supplied up to the necessary maximum electric power of 8,000 W, and sequentially melts the unmelted portion.

[0020]

The plasma control unit 9 similarly has a construction of changing the magnetic field control for converging the plasma when evaporating the raw material.

In the embodiment, when conducting the

variable plasma control, the plasma control unit 9

first converges the plasma in a first plasma region

necessary for evaporating the raw material, for

instance a region with a diameter of 10 mm about an

approximate center of the green compact 4. After that,

the unit controls the plasma so as to sequentially move

and expand it from the immediately preceding plasma

region. The plasma is thus continuously and

sequentially moved and expanded up to the maximum

plasma region with a diameter of 40 mm almost covering the whole green compact, and sequentially melts the unmelted portion.

[0021]

Examples of tools with films formed by the method according to the invention will be described below.

[Example 1]

A vaporizing raw material was prepared by die-molding 30 g of a mixed powder of Ti and Al having 10 metal components approximately close to an objective film composition into a tubular shape having a diameter of 40 mm, with the force of 2 GPa. The green compact was charged into the crucible (or hearth), the workpiece was heated and cleaned, and then, the green 15 compact was melted and evaporated in a mixture atmosphere of argon and nitrogen gases at a pressure of about 1 Pa. At this time, a HCD gun was used, which was set to converge the diameter of a plasma beam into about 10 mm on the top face of the green compact, and a 20 plasma output was increased by 500W per minute up to 8,000W. [0022]

At the same time, the plasma control was

25 performed so as to continuously and sequentially move
and expand the diameter of the plasma beam from the
region of the 10mm diameter about the approximate
center of the green compact so as to finally cover

almost the entire green compact of the 40 mm diameter to sequentially melt the unmelted portion.

A TiAlN film was formed from thus obtained vapor of the raw material on a high speed steel drill and a cemented carbide end mill which had a TiCN coating coated beforehand as an undercoat.
[0023]

The result of a cutting test with the obtained high speed steel drill is shown in Table 1

(item name: drill life). The test was conducted to use the high speed steel drill in cutting up to the breakage life.

(Cutting condition of the high speed steel drill)

tool: high speed steel drill of  $\phi 6$  cutting method: drilling, using 5 pieces of each example

work material: S50C (hardness 210 HB) cutting speed: 40 m/min, feed: 0.1 mm/rev

20 cutting length: 20 m (through hole), lubricant: dry type (none)

[0024]
[Table 1]

	Film thickness * um	Film hardness HV0.05	Drill life (hole)	End mill flank wear V <sub>B</sub> (mm)	Oxidiza- tion thickness um	
TiCN+TiAlN (green compact melting method)	Surface layer 1.3 Undercoat 1.6	3400	. 987	0.04	0.4	Invention
TiCN (melting method)	2.1	2800	416	17m stopped	All oxidized	Comparative example
TiCN+TiAlN (arc prosess)	Surface layer 2.5 Undercoat 0.2	3800	489	0.06	0.6	Comparative example
TiCN+TiAlN (alloy melting method)	Surface layer 0.9 Undercoat 1.7	3300	852	0.05	0.4	Comparative example

<sup>\*</sup> Film thicknesses are values measured on simultaneously installed test pieces of high speed steel (SKH51, Ra $\leq$ 0.2µm) with a carotest method (fretting mark method). [0025]

As is apparent from Table 1, the high speed steel drill with the hard film according to the invention shows the very long life almost twice as compared with the conventional examples. This is because the melting method forms almost no droplet and imparts small surface roughness.

According to the invention, the

10 multicomponent film containing metal components with
greatly different melting points such as TiAlN had such
adequate film quality as to show the desired
distribution of the respective, different metal
components over the whole film thickness. Further, as

for the vaporizing raw material, since it does not need to strictly match with the objective film composition, a raw alloy material having metal compounds approximately close to the objective film composition may be used and almost the whole parts of the material can be effectively used so that the material use efficiency is high.

[0026]

The green compact 4 has the cylindrical shape

10 and is placed in the water cooled 10 type crucible 3.

The atmosphere above the crucible 3 in the vacuum chamber is made in a plasma state, and the plasma 7 is controlled to converge on the raw material. A central part of the green compact 4 is melted and evaporated by

15 heat generated when forming the plasma, and the vapor is ionized.

When the sintered compact or the green compact is used as the starting raw material, the raw material is increased in apparent volume by heat and forms vacant gaps inside the sintered compact or green compact. The sintered compact or the green compact having the vacant gaps has a higher heat-insulating effect as compared with an alloy material and decreases the volume after having been melted. This allows the melted portion and the unmelted portion to be easily separated.

[0027]

[Example 2]

Cemented carbide inserts (A30) were coated under the condition of Example 1 and were heated to and held at 900°C for one hour in atmospheric air. The result of measuring the thicknesses of surface oxide

5 layers of the inserts is jointly written in Table 1 (item name: oxidization thickness). It is understood that since the film has less film defects such as droplets as compared with that according to the arc process (the conventional example), progression of oxidation is slow and the thickness of an oxidized layer is small (improves oxidation resistance).

[0028]

[Example 3]

A cemented carbide end mill previously coated

with a TiCN film in the condition of Example 1 was

coated with a TiAlN film. A wear width in the flank of

the cemented carbide end mill was measured after it had

cut the length of 60 m, and the result is written

together in Table 1 (item name: end mill flank wear).

Cutting conditions are shown below.

(Cutting condition of cemented carbide end mill)

tool:  $\phi 10$  cemented carbide square end mill with two cutting edges

cutting method: downward side cutting
work material: SKD61 (hardness 53 HRC)
depth of cut: 10 mm in axial direction and
0.2 mm in diametrical direction

cutting speed: 314 m/min, feed: 0.07 mm/edge cut length: 60 m, lubricant: none (air blow)

The cemented carbide end mill showed abrasion resistance equal to or slightly better than the TiAlN film formed by the arc process. Because the films have the same content, it is considered that the improvement of the oxidation resistance by reduction of droplets contributes to this result.

In the above, the invention has been described with reference to the embodiment, but the invention is not limited solely to this specific form, and the described form can be variously changed or the invention may take other forms within the scope of attached claims.

[0029]

For instance, although the embodiment melts, evaporates and ionizes the raw material together by forming the plasma, melting and evaporation of the raw material and ionization thereof may be separately carried out by using a heating device capable of changing a heating region. Further, although a magnetic field is used for convergence control of the plasma in the embodiment, it is needless to say that an electric field may be used.

Furthermore, in Example 1, the power supply control and the plasma control are both used in forming the coating film, but only one control of them may be used.

BRIEF DESCRIPTION OF THE DRAWING [0030]

[Fig. 1] A schematic view showing the whole configuration of a multicomponent film production stabilizing device according to an embodiment of the invention

[Fig. 2] A schematic sectional view for explaining the molten state of raw material of a green compact in the device of Fig. 1

[Fig. 3] A schematic sectional view of a crucible for explaining the molten state in the case of using a raw alloy material of a large area